| Electronic Paten                        | t App             | lication Fee   | Transmit | tal    |                         |  |  |
|---|-------------------|--|----------|--------|-------------------------|--|--|
| Application Number:                     | 10                | 10721382   |          |        |                         |  |  |
| Filing Date:                            | 26-               | 26-Nov-2003  |          |        |                         |  |  |
| Title of invention:                     | Hi <u>ç</u><br>pa | High density chip scale leadframe package and method of manufacturing th package |          |        |                         |  |  |
| First Named Inventor/Applicant Name:    | Hie               | Hien Boon Tan  |          |        |                         |  |  |
| Filer:                                  | Cai               | Carl Joseph Pellegrini/ruth swanson  |          |        |                         |  |  |
| Attorney Docket Number:                 | Q7                | Q78432   |          |        |                         |  |  |
| Filed as Large Entity                   |                   |  |          |        |                         |  |  |
| Utility under 35 USC 111(a) Filing Fees |                   |  |          |        |                         |  |  |
| Description                             |                   | Fee Code   | Quantity | Amount | Sub-Total in<br>USD(\$) |  |  |
| Basic Filing:                           |                   |  |          |        |                         |  |  |
| Pages:                                  |                   |  |          |        |                         |  |  |
| Claims:                                 |                   |  |          |        |                         |  |  |
| Miscellaneous-Filing:                   |                   |  |          |        |                         |  |  |
| Petition:                               |                   |  |          |        |                         |  |  |
| Patent-Appeals-and-Interference:        |                   |  |          |        | 1                       |  |  |
| Notice of appeal                        |                   | 1401   | 1        | 540    | 540                     |  |  |
| Post-Allowance-and-Post-Issuance:       |                   |  |          |        |                         |  |  |
| Extension-of-Time:                      |                   |  |          |        |                         |  |  |

| Description                       | Fee Code | Quantity          | Amount | Sub-Total in<br>USD(\$) |  |
|-----------------------------------|----------|-------------------|--------|-------------------------|--|
| Extension - 1 month with \$0 paid | 1251     | 1                 | 130    | 130                     |  |
| Miscellaneous:                    |          |                   |        |                         |  |
|                                   | Tot      | Total in USD (\$) |        |                         |  |